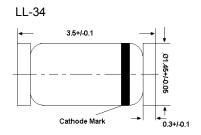


# **LL4148**

### Silicon Epitaxial Planar Switching Diode

Fast switching diode in MiniMELF case especially suited for automatic surface mounting



Glass case MiniMELF
Dimensions in mm

#### Absolute Maximum Ratings (T<sub>a</sub> = 25 °C)

Parameter		Symbol	Value	Unit
Peak Reverse Voltage		$V_{RM}$	100	V
Reverse Voltage		$V_R$	75	V
Average Rectified Forward Current		I <sub>F(AV)</sub>	200	mA
Non-repetitive Peak Forward Surge Current	at t = 1 s at t = 1 ms at t = 1 µs	I <sub>FSM</sub>	0.5 1 4	Α
Power Dissipation		P <sub>tot</sub>	500 <sup>1)</sup>	mW
Junction Temperature		T <sub>j</sub>	175	°C
Storage Temperature Range		T <sub>stg</sub>	- 65 to + 175	°C
1) Valid provided that also trades are least at amplicant	to man a rati ira			

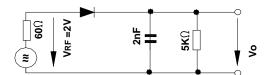
<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature.

## LL4148

### Characteristics at T<sub>a</sub> = 25 °C

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at I <sub>F</sub> = 10 mA	V <sub>F</sub>	-	1	V
Leakage Current at $V_R$ = 20 V at $V_R$ = 75 V at $V_R$ = 20 V, $T_j$ = 150 °C	I <sub>R</sub> I <sub>R</sub>		25 5 50	nΑ μΑ μΑ
Reverse Breakdown Voltage tested with 100 µA Pulses	V <sub>(BR)R</sub>	100	-	٧
Capacitance at $V_R = 0$ , $f = 1$ MHz	C <sub>tot</sub>	-	4	pF
Voltage Rise when Switching ON tested with 50 mA Forward Pulses tp = 0.1 s, Rise Time < 30 ns, fp = 5 to 100 KHz	V <sub>fr</sub>	-	2.5	V
Reverse Recovery Time at $I_F$ = 10 mA to $I_R$ = 1 mA, $V_R$ = 6 V, $R_L$ = 100 $\Omega$	t <sub>rr</sub>	-	4	ns
Thermal Resistance Junction to Ambient Air	R <sub>thA</sub>	-	0.35 <sup>1)</sup>	K/mW
Rectification Efficiency at f = 100 MHz, V <sub>RF</sub> = 2 V	$\eta_{\vee}$	0.45	-	-

<sup>&</sup>lt;sup>1)</sup> Valid provided that electrodes are kept at ambient temperature.



**Rectification Efficiency Measurement Circuit** 

